THE DATASHEET OF

BSR302NL6327HTSA1

OptiMOS®2 Small-Signal-Transistor

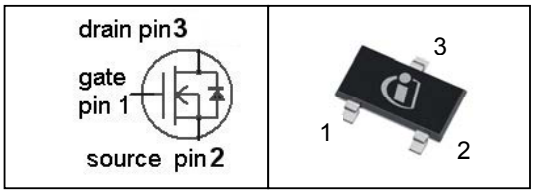
Features

- N-channel
- Enhancement mode
- Logic level (4.5V)
- Avalanche rated
- Footprint compatible to SOT23
- d*v*/d*t* rated
- Pb-free lead plating; RoHS compliant
- Qualified according to AEC Q101

Product Summary

V_{DS}		30	V
$R_{DS(on),max}$	V_{GS}=10 V	23	mΩ
	V_{GS}=4.5 V	36	
I_D		3.7	A

PG-SC-59



Type	Package	Tape and Reel Information	Marking	Lead Free	Packing
BSR302N	PG-SC-59	L6327 = 3000 pcs. / reel	LEs	Yes	Non dry

Maximum ratings, at T_j=25 °C, unless otherwise specified

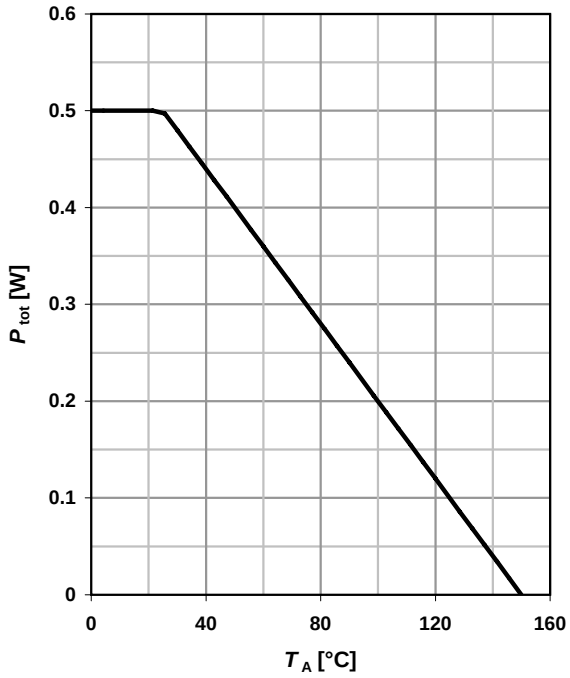
Parameter	Symbol	Conditions	Value	Unit
Continuous drain current	I_D	T_A=25 °C	3.7	A
		T_A=70 °C	2.9	
Pulsed drain current	$I_{D,pulse}$	T_A=25 °C	14.7	
Avalanche energy, single pulse	E_{AS}	I_D=3.7 A, R_{GS}=25 Ω	30	mJ
Reverse diode d*v*/d*t*	d*v*/d*t*	I_D=3.7 A, V_{DS}=16 V, d*i*/d*t*=200 A/µs, $T_{j,max}$=150 °C	6	kV/µs
Gate source voltage	V_{GS}		±20	V
Power dissipation	P_{tot}	T_A=25 °C	0.5	W
Operating and storage temperature	T_j, T_{stg}		-55 ... 150	°C
ESD Class		JESD22-A114-HMB	0 (0V to 250V)	
Soldering Temperature			260 °C	
IEC climatic category; DIN IEC 68-1			55/150/56	

Parameter	Symbol	Conditions	Values			Unit
			min.	typ.	max.	
Thermal characteristics						
Thermal resistance, junction - minimal footprint	R_{thJA}		-	-	250	K/W
Electrical characteristics, at T_j=25 °C, unless otherwise specified						
Static characteristics						
Drain-source breakdown voltage	$V_{(BR)DSS}$	V_{GS}=0 V, I_D=250 µA	30	-	-	V
Gate threshold voltage	$V_{GS(th)}$	V_{DS}=V_{GS} , I_D=30 µA	1.2	1.7	2	
Drain-source leakage current	I_{DSS}	V_{DS}=30 V, V_{GS}=0 V, T_j=25 °C	-	-	1	µA
		V_{DS}=30 V, V_{GS}=0 V, T_j=150 °C	-	-	100	
Gate-source leakage current	I_{GSS}	V_{GS}=20 V, V_{DS}=0 V	-	-	100	nA
Drain-source on-state resistance	$R_{DS(on)}$	V_{GS}=4.5 V, I_D=2.9 A	-	26	36	mΩ
		V_{GS}=10 V, I_D=3.7 A	-	18	23	
Transconductance	g_{fs}	$\|V_{DS}\|>2\|I_D\|R_{DS(on)max}$, I_D=3.7 A		12	-	S

Parameter	Symbol	Conditions	Values			Unit
			min.	typ.	max.	
Dynamic characteristics						
Input capacitance	C_{iss}	V_{GS}=0 V, V_{DS}=15 V, f=1 MHz	-	564	750	pF
Output capacitance	C_{oss}		-	202	269	
Reverse transfer capacitance	C_{rss}		-	28	43	
Turn-on delay time	$t_{d(on)}$	V_{DD}=15 V, V_{GS}=10 V, I_D=3.7 A, R_G=2.7 Ω	-	6.8	-	ns
Rise time	t_r		-	3.2	-	
Turn-off delay time	$t_{d(off)}$		-	16.2	-	
Fall time	t_f		-	2.2	-	
Gate Charge Characteristics						
Gate to source charge	Q_{gs}	V_{DD}=15 V, I_D=3.7 A, V_{GS}=0 to 5 V	-	1.6	2.2	nC
Gate to drain charge	Q_{gd}		-	1.1	1.7	
Gate charge total	Q_g		-	4.4	6.6	
Gate plateau voltage	$V_{plateau}$		-	2.9	-	V
Reverse Diode						
Diode continous forward current	I_S	T_A=25 °C	-	-	0.8	A
Diode pulse current	$I_{S,pulse}$		-	-	14.7	
Diode forward voltage	V_{SD}	V_{GS}=0 V, I_F=3.7 A, T_j=25 °C	-	0.8	1.2	V
Reverse recovery time	t_{rr}	V_R=15 V, I_F=3.7 A, di_F/dt=100 A/µs	-	13.5		ns
Reverse recovery charge	Q_{rr}		-	5.0	-	nC

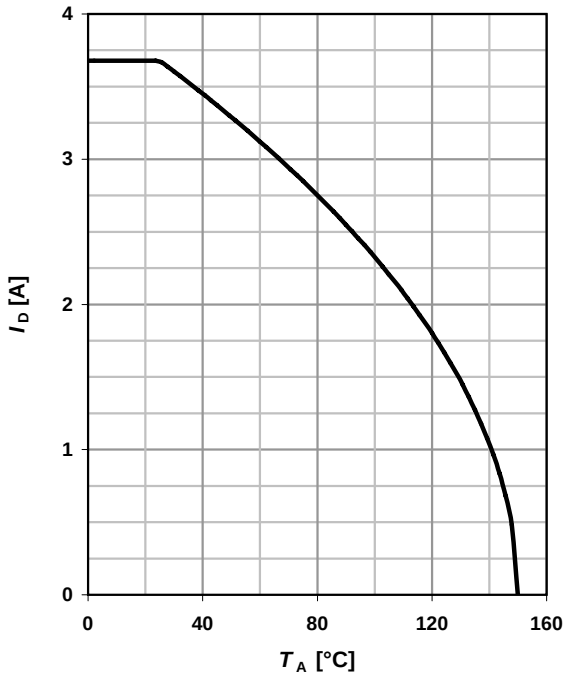
1 Power dissipation

$P_{tot}=f(T_A)$



2 Drain current

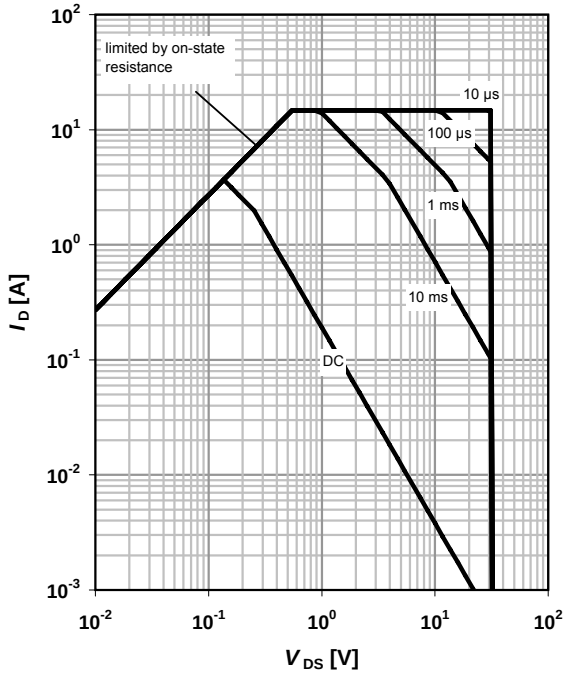
$I_D=f(T_A)$; $V_{GS}\geq 10$ V



3 Safe operating area

$I_D=f(V_{DS})$; $T_A=25$ °C; $D=0$

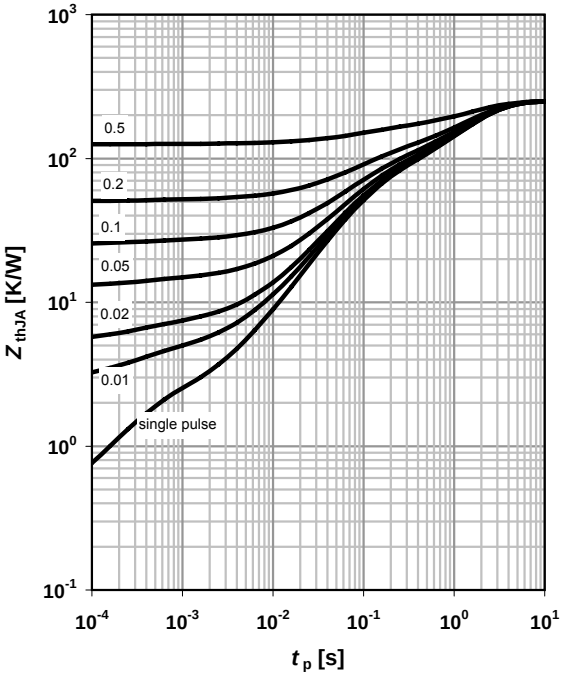
parameter: t_p



4 Max. transient thermal impedance

$Z_{thJA}=f(t_p)$

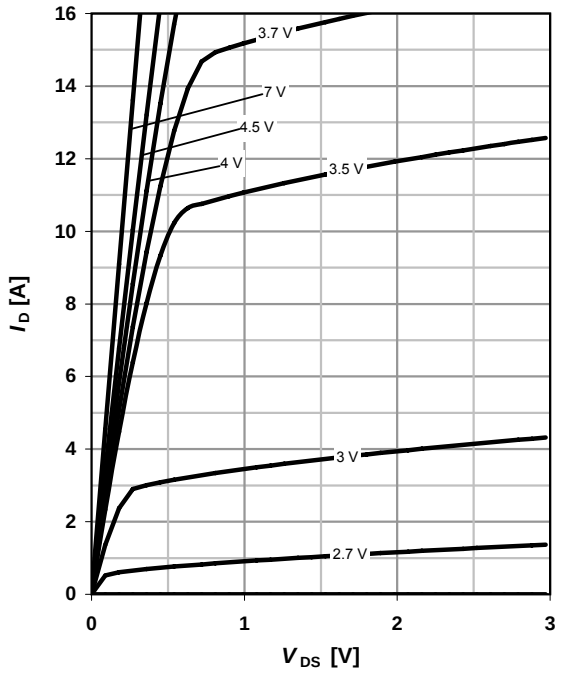
parameter: $D=t_p/T$



5 Typ. output characteristics

I_D=f(V_{DS}); T_j=25 °C

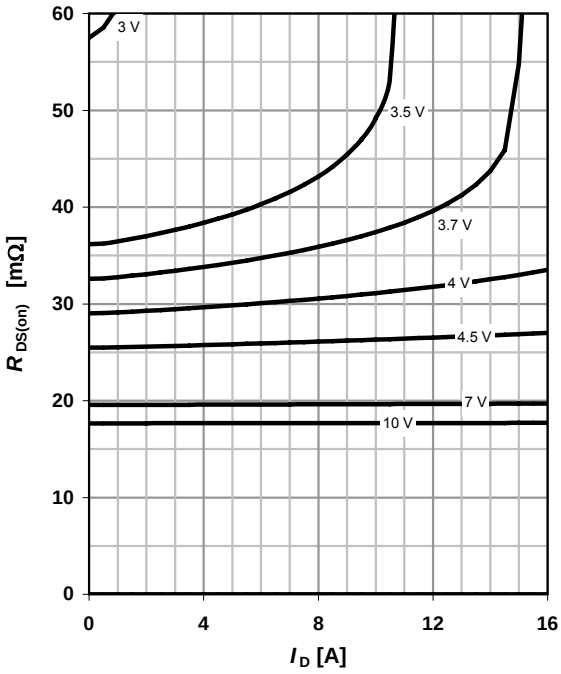
parameter: V_{GS}



6 Typ. drain-source on resistance

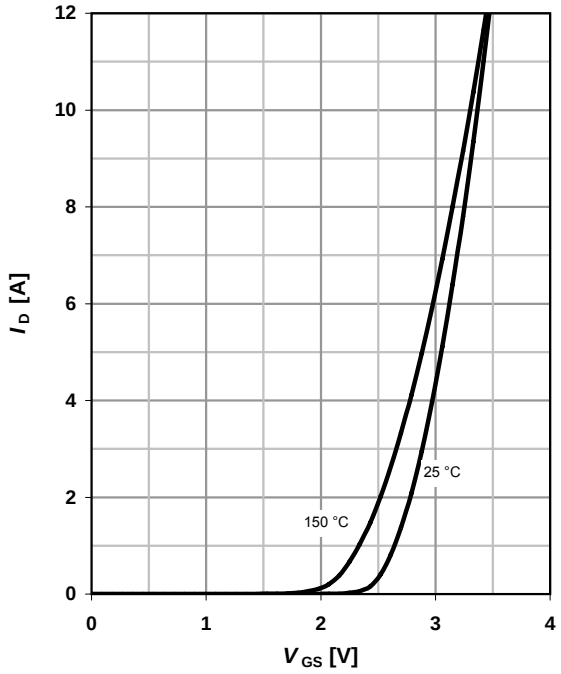
$R_{DS(on)}$=f(I_D); T_j=25 °C

parameter: V_{GS}



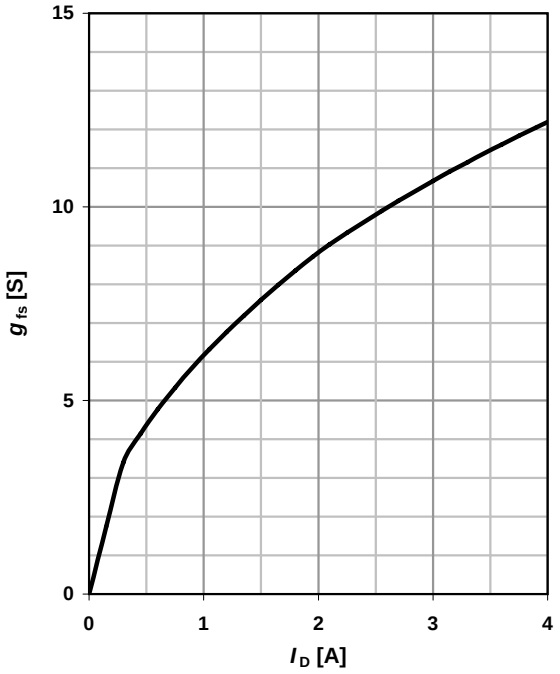
7 Typ. transfer characteristics

I_D=f(V_{GS}); $|V_{DS}|>2|I_D|R_{DS(on)max}$



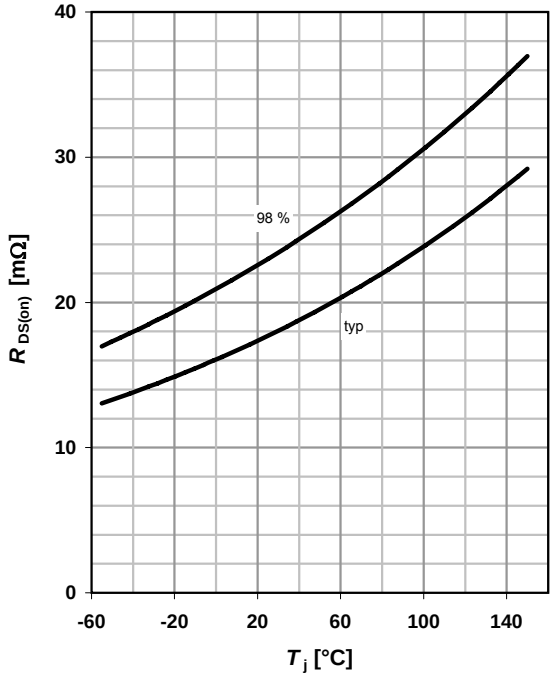
8 Typ. forward transconductance

g_{fs}=f(I_D); T_j=25 °C



9 Drain-source on-state resistance

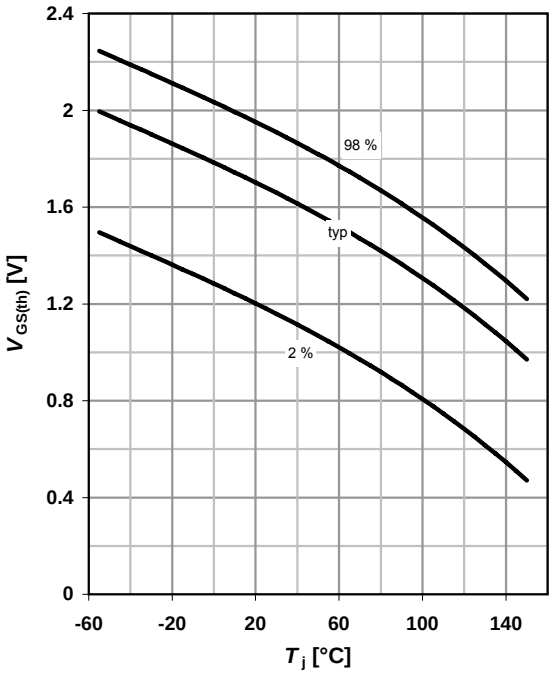
$R_{DS(on)}$=f(T_j); I_D=3.7 A; V_{GS}=10 V



10 Typ. gate threshold voltage

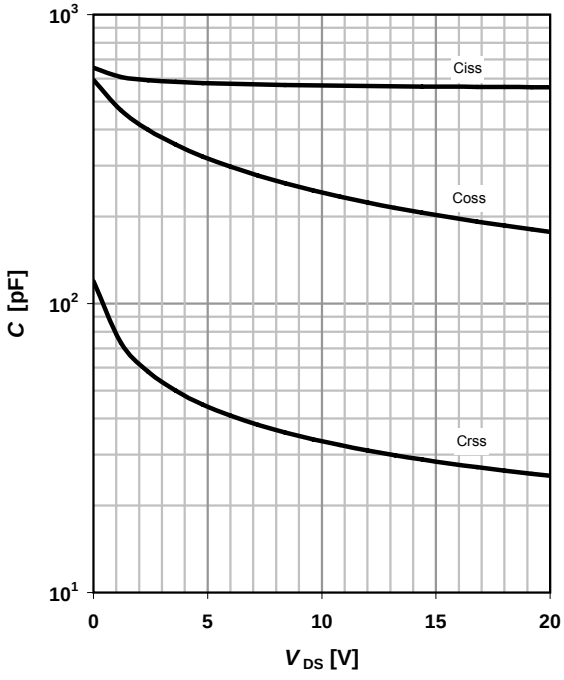
$V_{GS(th)}$=f(T_j); V_{DS}=V_{GS}; I_D=30 µA

parameter: I_D



11 Typ. capacitances

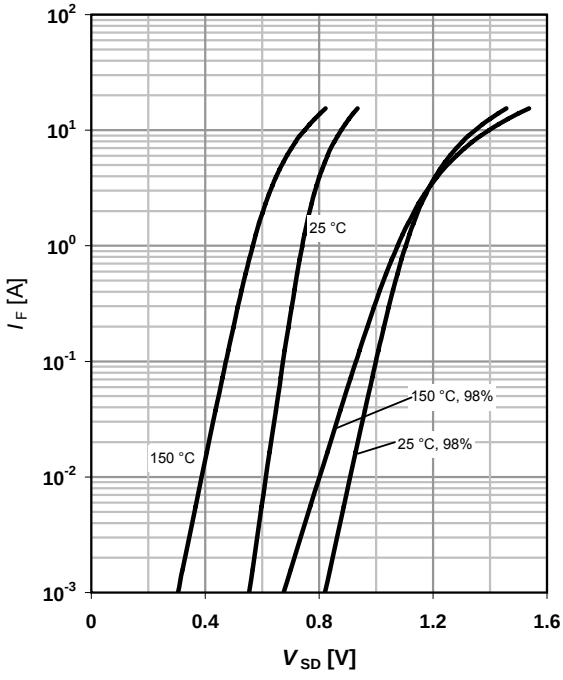
C=f(V_{DS}); V_{GS}=0 V; f=1 MHz; T_j=25°C



12 Forward characteristics of reverse diode

I_F=f(V_{SD})

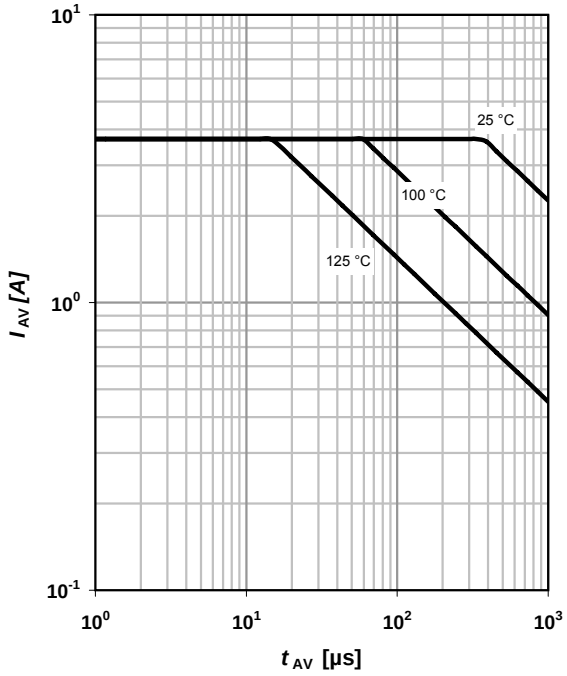
parameter: T_j



13 Avalanche characteristics

I_{AS}=f(t_{AV}); R_{GS}=25 Ω

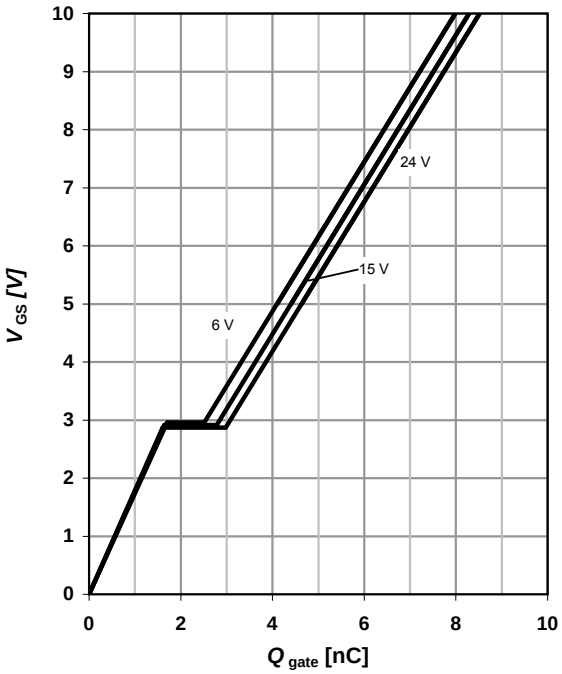
parameter: $T_{j(start)}$



14 Typ. gate charge

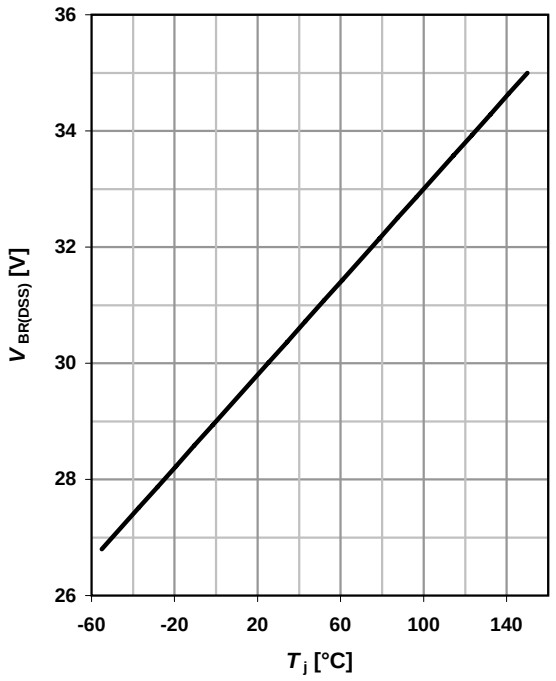
V_{GS}=f(Q_{gate}); I_D=3.7 A pulsed

parameter: V_{DD}

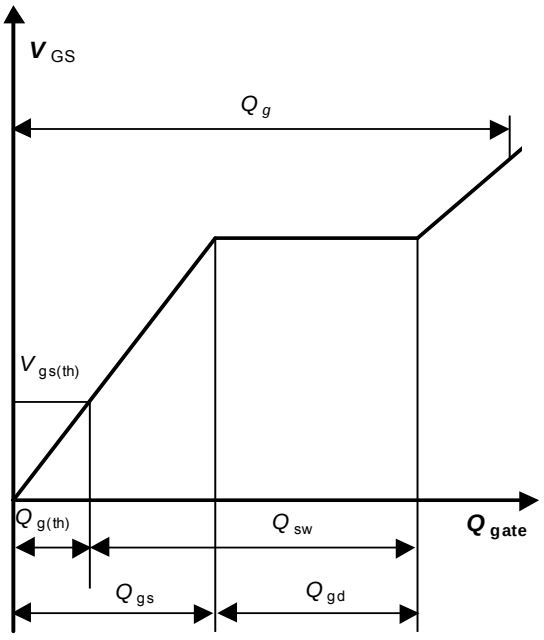


15 Drain-source breakdown voltage

$V_{BR(DSS)}$=f(T_j); I_D=250 µA

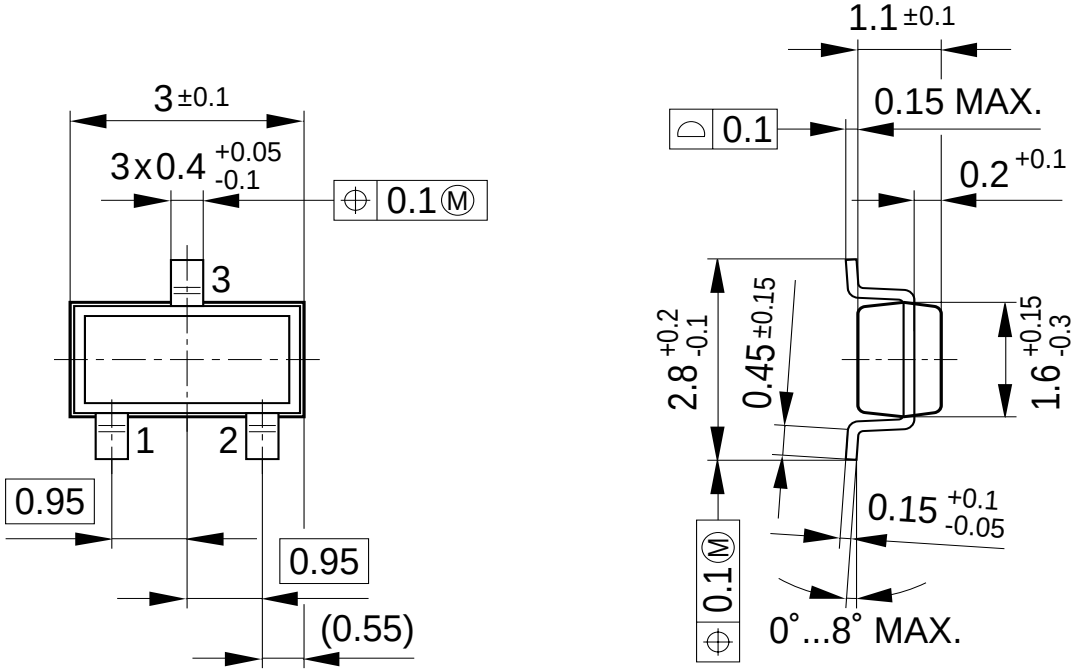


16 Gate charge waveforms



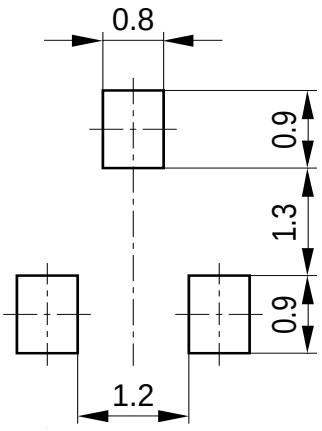
Package Outline:

PG-SC59



GPS09473

Footprint:



HLG09474

Dimensions in mm

Published by
Infineon Technologies AG
81726 Munich, Germany

Legal Disclaimer

The information given in this document shall in no event be regarded as a guarantee of conditions or characteristics. With respect to any examples or hints given herein, any typical values stated herein and/or any information regarding the application of the device, Infineon Technologies hereby disclaims any and all warranties and liabilities of any kind, including without limitation, warranties of non-infringement of intellectual property rights of any third party.

Information

For further information on technology, delivery terms and conditions and prices, please contact the nearest Infineon Technologies Office (www.infineon.com).

Warnings

Due to technical requirements, components may contain dangerous substances. For information on the types in question, please contact the nearest Infineon Technologies Office.
Infineon Technologies components may be used in life-support devices or systems only with the express written approval of Infineon Technologies, if a failure of such components can reasonably be expected to cause the failure of that life-support device or system or to affect the safety or effectiveness of that device or system. Life support devices or systems are intended to be implanted in the human body or to support and/or maintain and sustain and/or protect human life. If they fail, it is reasonable to assume that the health of the user

Looking for pricing, stock, or lifecycle information?

Click below to explore more details on WIN SOURCE:

- View BSR302NL6327HTSA1 on WIN SOURCE
- Infineon Technologies Information

Optimize Your Supply Chain with WIN SOURCE Solutions

- Global Sourcing Solution
- Obsolete Management
- Cost Control Management
- Shortage Management
- Alternative Solution
- Excess Inventory Management